1-31-92 To the Honorable Commissioner of Patents and Tradellars base record the attached original documents or copy thereof. 2. Name and address of receiving party(ies): Name of conveying party(ies): Thomas Wong Han Boon Name: Advanced Micro Devices, Inc. Hasan Bin Odek Peter Heng Yiak Khian Internal Address: \_\_\_\_\_ Additional name(s) of conveying party(ies) attached? 

Yes X No 3. Nature of conveyance: Street Address: One AMD Place X Assignment □ Merger ☐ Security Agreement Change of Name City: Sunnyvale State: CA ZIP 94088 ☐ Other \_\_\_\_\_ Additional name(s) & address(es) attached? ☐ Yes X No Execution Date: April 13, 1999 4. Application number(s) or patent number(s): (Atty. Docket No. 99A-1927) If this document is being filed together with a new application, execution date of the application is: April 13, 1999 B. Patent No.(s) A. Patent Application No.(s) 09.298497 Additional numbers attached? 

Yes X No 5. Name and address of party to whom correspondence 6. Total number of applications and patents involved: concerning document should be mailed: Name: <u>DAVIS CHIN</u> 7. Total fee (37 CFR 3.41): . . . . . . . . . . . . \$ \_40.00 Internal Address: Enclosed Law Offices of Davis Chin Authorized to be charged to deposit account Street Address: 111 W. Washington St., 8. Deposit account number: Suite 1025 01-0365 City: Chicago State: IL ZIP: 60602 (Attach duplicate copy of this page if paying by deposit account) DO NOT USE THIS SPACE 4/30/1999 DMGUYEN \_6000024B\_010365 09298447 1 FC:581 40.00 CH 9. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. Hpp: 2/ 1999 DAVIS CHIN Name of Person Signing Total number of pages comprising cover sheet:

PATENT

**REEL: 9915 FRAME: 0628** 

99A-1927

<u>ASSIGNMENT</u>

WHEREAS, the undersigned, Thomas Wong Han Boon, residing at Blk 109,

Serangoon North Ave. 1, #12-649, Singapore 550109; and Hasan Bin Odek, residing

at Blk 302, Tampines S7 32, #06-42, Singapore 520302; and Peter Heng Yiak

Khian, residing at Blk 135, Simei St 1, #11-72, Singapore 520135,

(hereinafter termed Assignors), have invented certain new and useful

improvements in PLASTIC AND METAL TUBE HOLDER FOR SOIC PACKAGE for which a

United States patent application has been concurrently executed on the date

of this assignment.

WHEREAS, ADVANCED MICRO DEVICES, INC., a corporation of the State of

Delaware, having a place of business at One AMD Place, P. O. Box 3453,

Sunnyvale, California 94088 (hereinafter termed Assignee), is desirous of

acquiring the entire right, title and interest in and to said application and

said invention and improvements thereon, and in and to Letters Patent thereon

when granted in the United States and foreign countries.

NOW, THEREFORE, for good and valuable consideration received by said

Assignors from said Assignee, the receipt of which is hereby acknowledged by

said Assignors:

1. Said Assignors do hereby sell, assign, transfer and convey unto said

Assignee, the entire right, title and interest in and to said application and

said invention and in and to any and all improvements on said invention

heretofore or hereafter made or acquired by said Assignors; and in and to any

and all Letters Patent on said invention and/or said improvements that may be

granted in the United States or any foreign country, including each and every

PATENT REEL: 9915 FRAME: 0629

P!12

Letters Patent granted on any application which is a division, continuation, substitution, renewal, or continuation-in-part of any said application, and in and to each and every reissue or extension of said Letters Patent.

- 2. Said Assignors hereby covenant and agree to cooperate with said Assignee whereby said Assignee may enjoy to the fullest extent the right, title and interest herein conveyed. Such cooperation shall include (a) prompt execution of all papers (prepared at the expense of Assignee) which are deemed necessary or desirable by Assignee to perfect in it the right, title and interest herein conveyed, (b) prompt execution of all petitions, oaths, specifications or other papers (prepared at the expense of Assignee) which are deemed necessary or desirable by Assignee for prosecuting said application, for filing and prosecuting divisional, continuation, substitution, renewal, continuation-in-part, or additional applications in the United States and/or foreign countries covering said invention and/or said improvements, for filing and prosecuting applications for reissuance of Letters Patent included herein, or for interference proceedings involving said invention and/or said improvements, and (c) prompt assistance and cooperation in the prosecution of interference proceedings involving said invention and/or said improvements and in the adjudication of said Letters Patent, particularly by the disclosure of facts and the production of evidence relating to said invention and/or said improvements, provided the expenses which may be incurred by said Assignors in lending such assistance and cooperation shall be paid by the Assignee.
- 3. The terms, covenants and conditions of this assignment shall inure to the benefit of said Assignee, its successors, assigns and/or other legal representatives and shall be binding upon said Assignors, their heirs, legal representatives and assigns.

- 2 -

4. Said Assignors hereby warrant and represent that they have not entered into any assignment, contract or understanding in conflict herewith.

IN WITNESS WHEREOF, the Assignors have executed and delivered this instrument on the dates set forth below.

04/13/99

Thomas Wong Han Boon

04/13/99

DATE

04/13/99

DATE

Odek Hasan Bin

Peter Heng Yiak Khian